NSN 5962-01-311-3746

Memory Microcircuit - Page 1 of 1

Fiig: A458a0



View Online at https://aerobasegroup.com/nsn/5962-01-311-3746 **Overall Height:** Between 0.630 inches and 0.770 inches **Body Outside Diameter:** Between 0.550 inches and 0.650 inches **Body Height:** Between 0.270 inches and 0.330 inches **Maximum Power Dissipation Rating:** 1.5 watts **Operating Tempurature Range:** -55.0/+125.0 degrees celsius Storage Tempurature Range: -65.0/+150.0 degrees celsius **Features Provided:** Low impedance and fast settling and monolithic **Inclosure Material:** Metal **Inclosure Configuration:** Can **Input Circuit Pattern:** 2 input **Case Outline Source And Designator:** To-8 joint electron device engineering council **Terminal Surface Treatment:** Solder Voltage Rating And Type Per Characteristic: 20.0 volts power source **Memory Device Type:** Rom **Test Data Document:** 96906-mil-std-883 standard (includes industry or association standards, individual manufactureer standards, etc.). **Terminal Type And Quantity:** 12 pin Shelf Life: N/a **Unit Of Measure: Demilitarization:** No